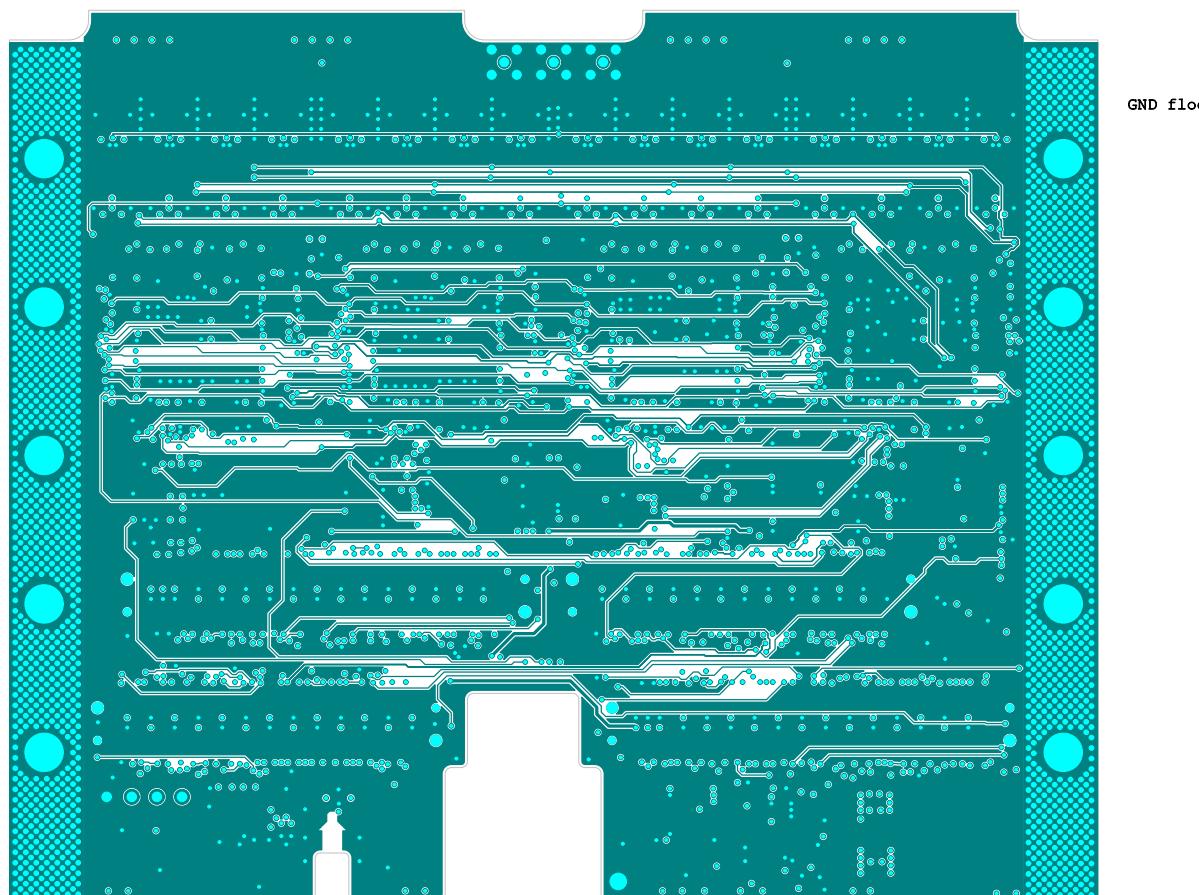
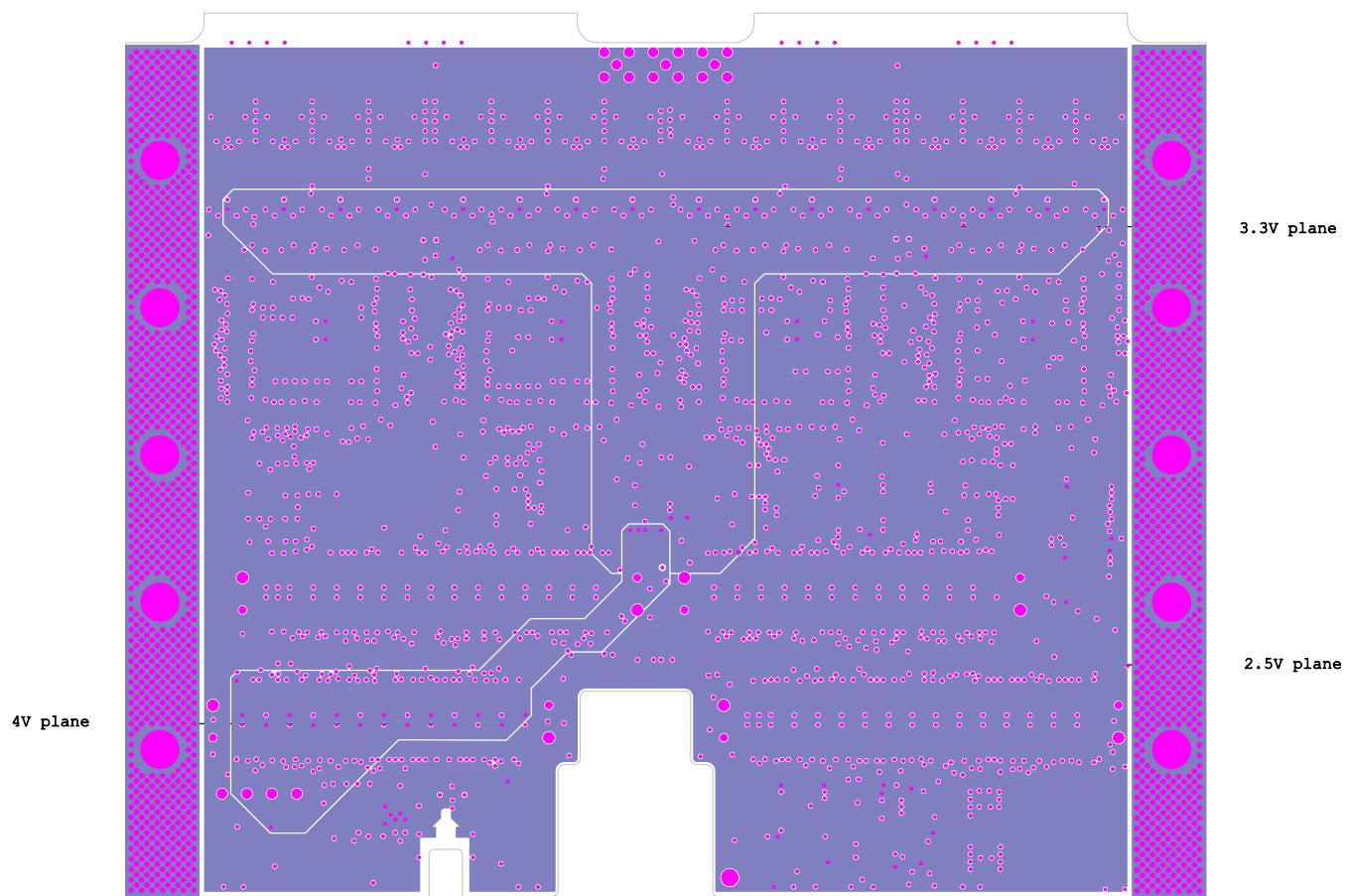
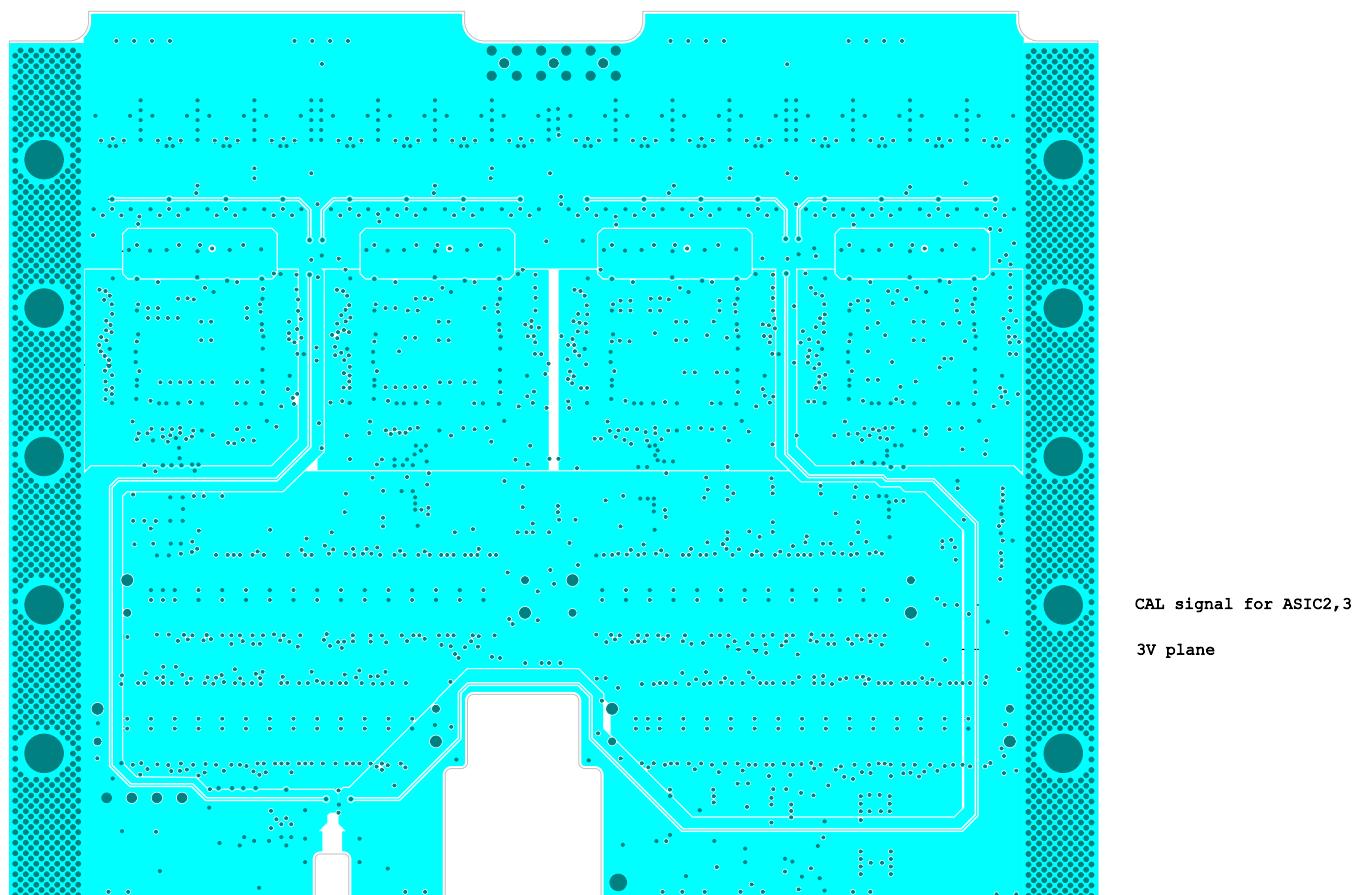
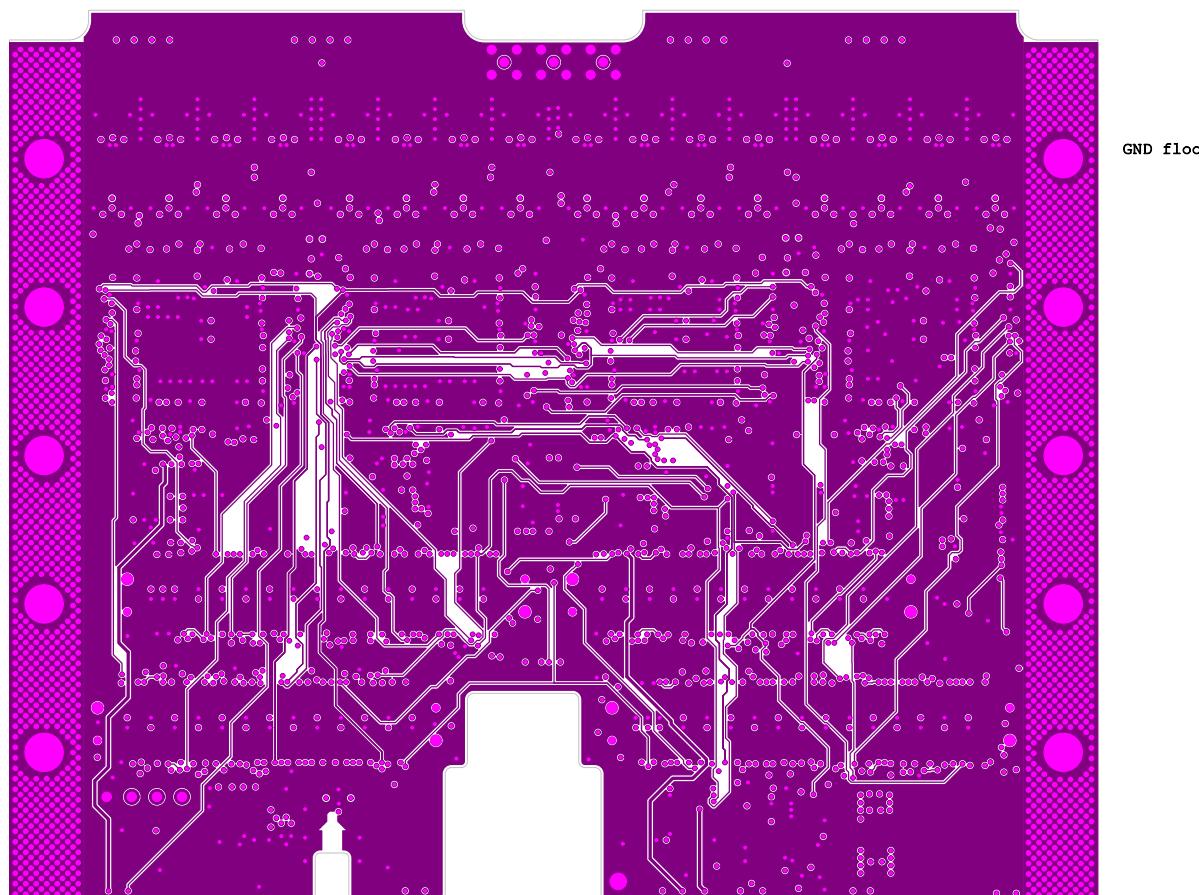


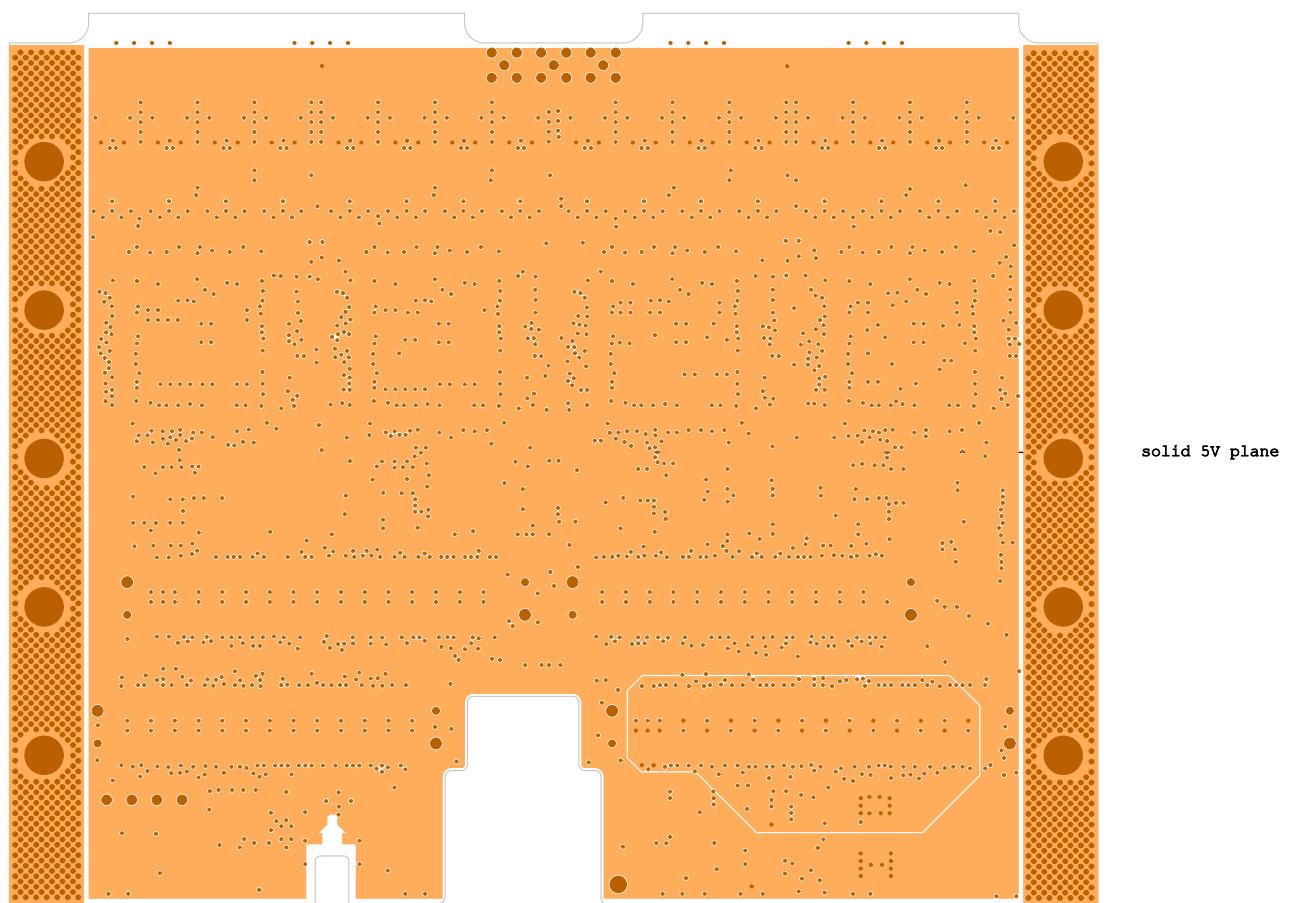
solid GND plane

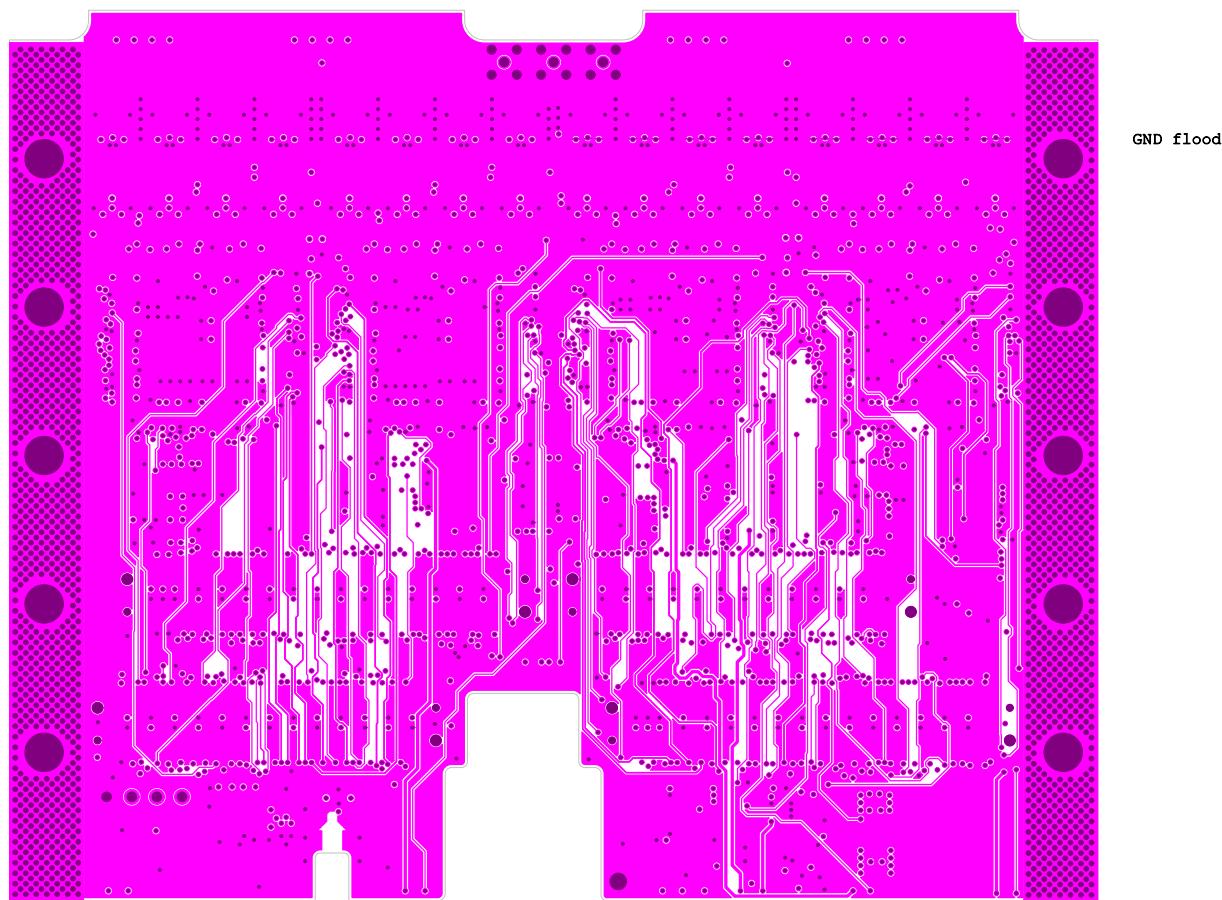


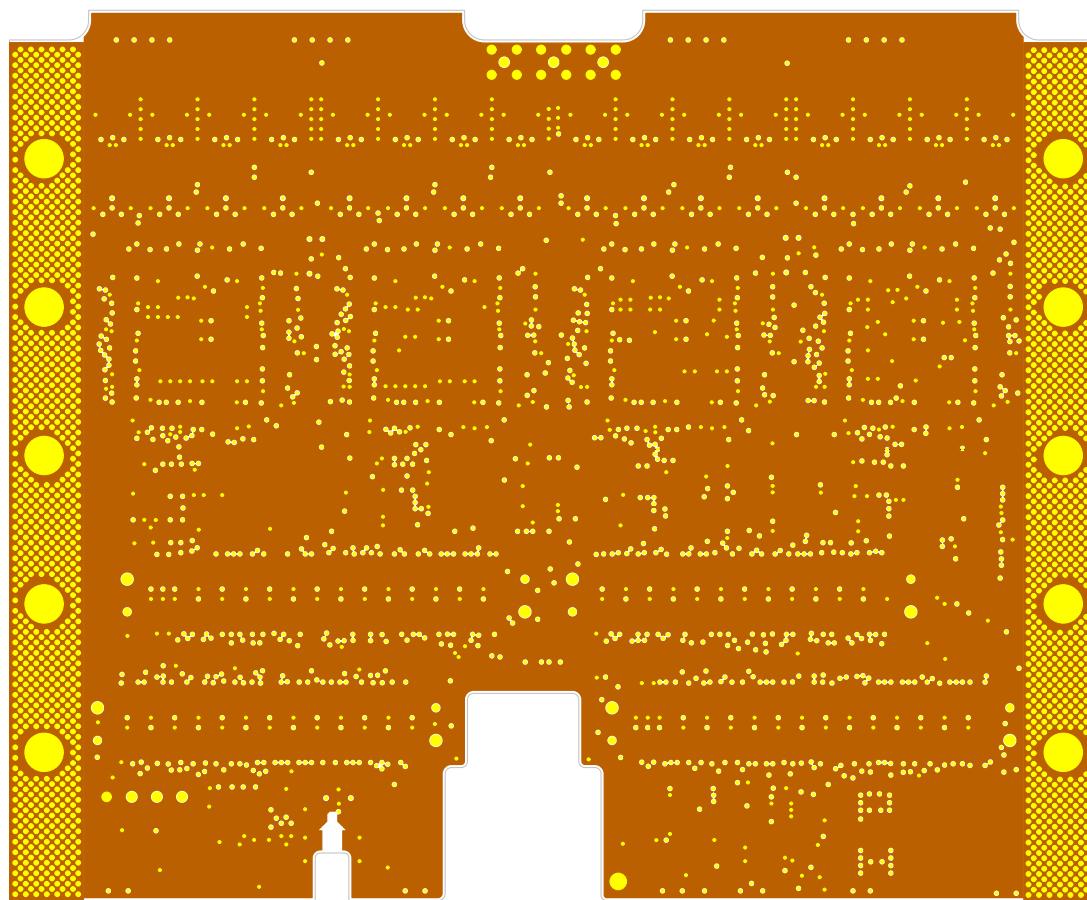




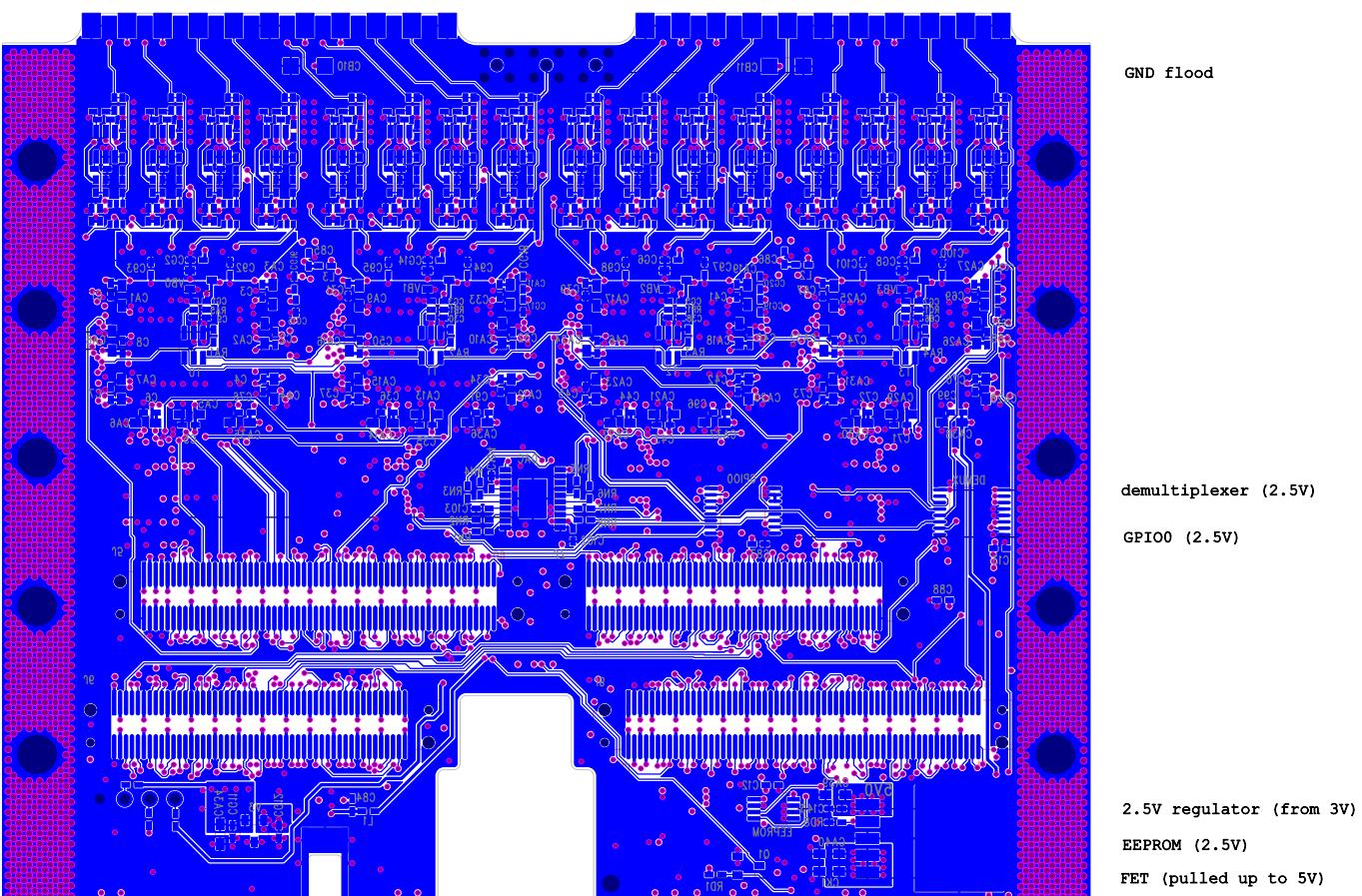




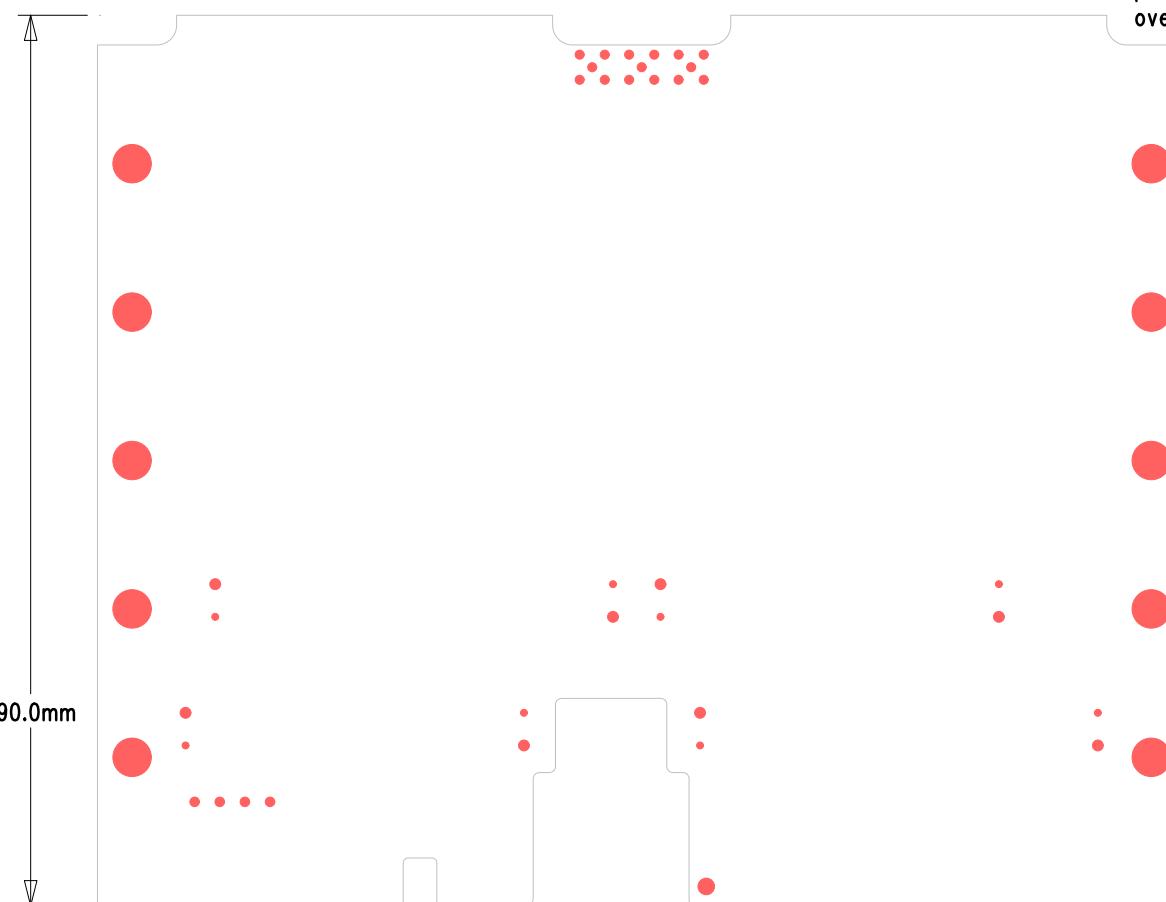




solid GND plane



overall board dimensions = 110 mm * 90 mm
 plated edges: left and right (see file edge-plating.gerber)
 left/right edge plating should connect electrically to all inner layers
 silkscreen color = white
 soldermask color = blue
 plating = ENIG
 overall thickness = 69 mils, after ENIG plating, ignoring soldermask



layer stackup		
dielectric	copper	layer # / description
9 mils	1 oz	1 top routing
3.15 mils	1 oz	2 GND
3.15 mils	1 oz	3 horizontal-routing
8 mils	1 oz	4 2.5V 3.3V 4V
8 mils	1 oz	5 1.25V 2.5V 3V GND CAL
8 mils	1 oz	6 routing
3.15 mils	1 oz	7 5V
3.15 mils	1 oz	8 vertical-routing
9 mils	1 oz	9 GND
	1 oz	10 bottom routing

